

HD74HCT138

3-to-8-line Decoder/Demultiplexer

REJ03D0659-0200 (Previous ADE-205-547) Rev.2.00 Mar 30, 2006

Description

The HD74HCT138 has 3 binary select inputs (A, B, and C). If the device is enabled these inputs determine which one of the eight normally high outputs will go low. Two active low and one active high enables (G_1 , G_{2A} and G_{2B}) are provided to ease the cascading of decoders.

Features

• High Speed Operation: t_{pd} (A, B, C to Y) = 16.5 ns typ ($C_L = 50 \text{ pF}$)

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2 \text{ V}$ to 6 V

• Low Input Current: 1 µA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HCT138P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74HCT138FPEL	SOP-16 pin (JEITA)	PRSP0016 DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

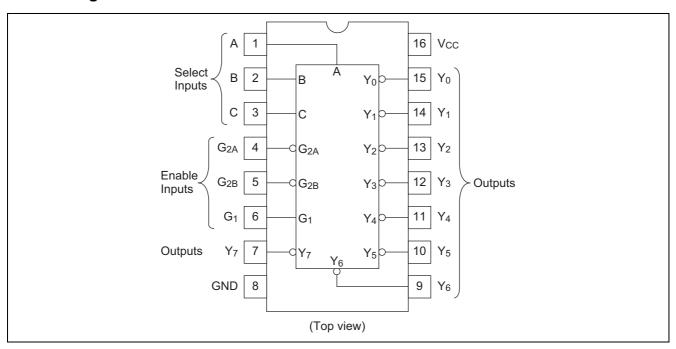
Note: Please consult the sales office for the above package availability.

Function Table

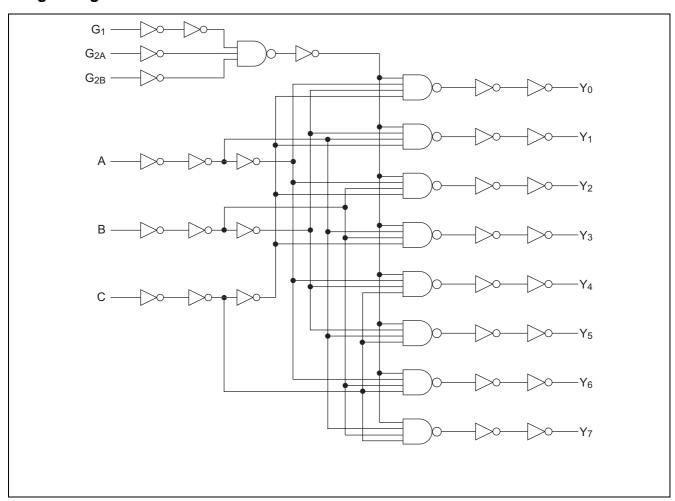
	Inputs						Outputs						
	Enable			Select			Outputs						
G ₁	G _{2A}	G _{2B}	С	В	Α	Y ₀	Y ₁	Y ₂	Y ₃	Y ₄	Y ₅	Y ₆	Y ₇
Х	Х	Н	Х	X	Х	Н	Н	Н	Н	Н	Н	Н	Н
X	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
L	Х	Х	Х	X	Х	Н	Н	Н	Н	Н	Н	Н	Н
Н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
Н	L	L	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н
Н	L	L	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
Н	L	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
Н	L	L	Н	L	L	Н	Н	Н	Н	L	Н	Н	Н
Н	L	L	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

H: High level
L: Low level
X: Irrelevant

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to +7.0	V
Input voltage	V_{IN}	-0.5 to V_{CC} + 0.5	V
Output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Output current	I _{OUT}	±25	mA
DC current drain per V _{CC} , GND	I _{CC} , I _{GND}	±50	mA
DC input diode current	I _{IK}	±20	mA
DC output diode current	Іок	±20	mA
Power dissipation per package	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	4.5 to 5.5	V	
Input / Output voltage	V_{IN}, V_{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
Input rise / fall time*1	t _r , t _f	0 to 500	ns	V _{CC} = 4.5 V

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

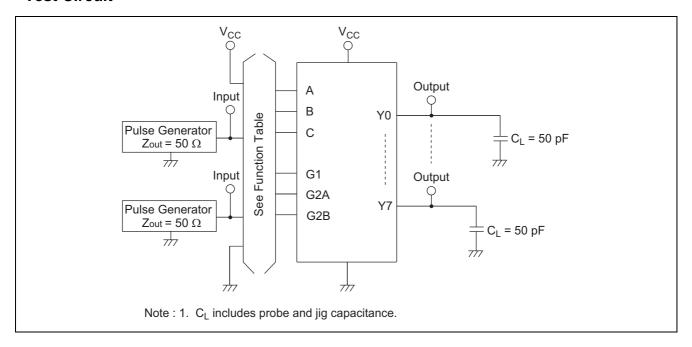
Item	Symbol	V _{cc} (V)	Ta = 25°C			Ta = -40 to+85°C		Unit	Test Conditions	
	Symbol		Min	Тур	Max	Min	Max	Oilit	rest Conditions	
Input voltage	V _{IH}	4.5 to 5.5	2.0	_	_	2.0	_	V		
	V _{IL}	4.5 to 5.5	_	_	0.8	_	0.8	V		
Output voltage	V _{OH}	4.5	4.4	_	_	4.4	_	V	Vin = V _{IH} or V _{IL}	$I_{OH} = -20 \mu A$
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
	V _{OL}	4.5	_	_	0.1	_	0.1	V	$Vin = V_{IH} or V_{IL}$	$I_{OL} = 20 \mu\text{A}$
		4.5	_	_	0.26	_	0.33			I _{OL} = 4 mA
Input current	lin	5.5	_	_	±0.1	_	±1.0	μΑ	$Vin = V_{CC}$ or GN	ID .
Quiescent supply current	I _{CC}	5.5	_	_	4.0	_	40	μА	Vin = V _{CC} or GN	ID, lout = $0 \mu A$

Switching Characteristics

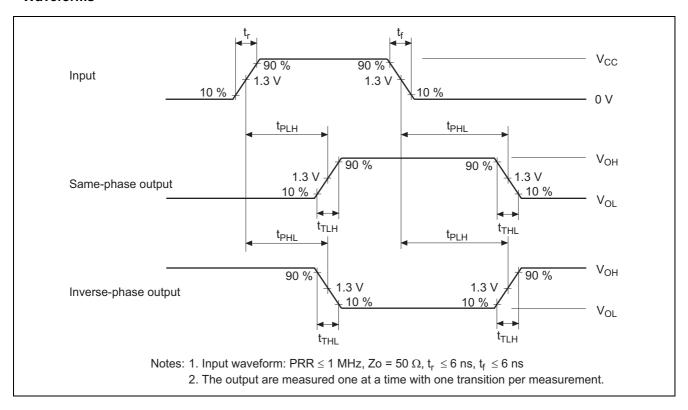
 $(C_L = 50 \text{ pF, Input } t_r = t_f = 6 \text{ ns})$

Item	Symbol	V _{CC} (V)	Ta = 25°C			Ta = -40 to +85°C		Unit	Test Conditions	
item	Symbol		Min	Тур	Max	Min	Max	Omit	rest Conditions	
Propagation delay time	t _{PHL}	4.5	_	18	35	_	44	ns	A, B or C to output	
	t _{PLH}	4.5	_	19	30	_	38	ns		
	t _{PHL}	4.5	_	17	30	_	38	ns	G₁ to output	
	t _{PLH}	4.5	_	17	30	_	38	ns		
	t _{PHL}	4.5	_	17	35	_	44	ns	G _{2A} or G _{2B} to output	
	t _{PLH}	4.5	_	17	30	_	38	ns		
Output rise/fall time	t _{TLH}	4.5	_	5	15	_	19	ns		
	t _{THL}									
Input capacitance	Cin	_	_	5	10		10	pF		

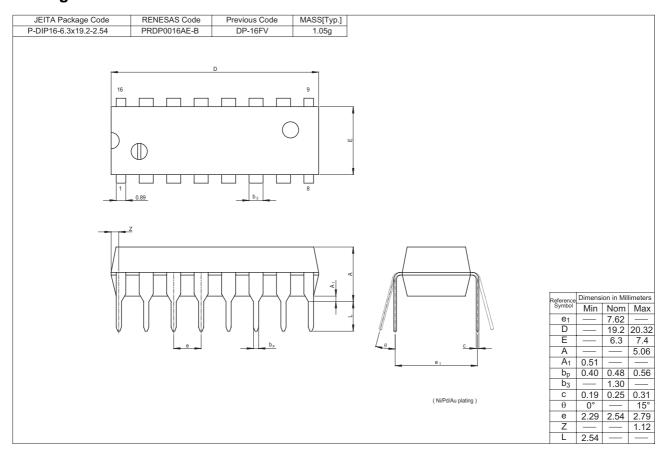
Test Circuit

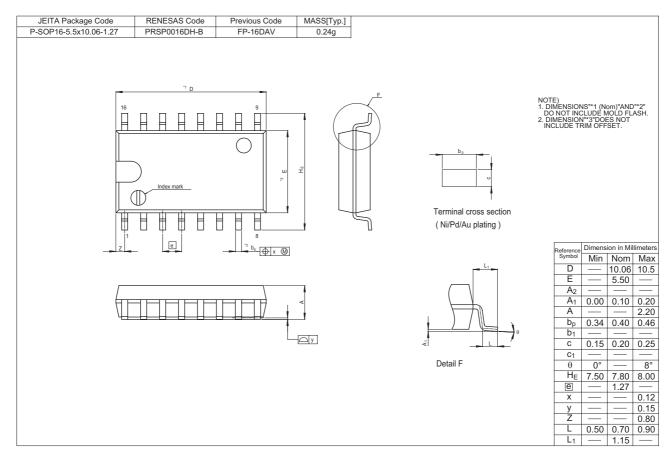


Waveforms



Package Dimensions





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